



Rear I/O



## Features

- Intel® Atom® x6414RE/x6212RE Processors (formerly Elkhart Lake)
- GPIO 4-in/4-out & 1x DVI-I & 1x HDMI
- Over/Under/Reverse voltage protection
- Extended operating temperature from -20°C to 70°C
- 9V~36V DC wide-range power input
- 1x M.2 B-Key 3052 support 5G module
- Optional 1x 2.5" SSD (AGS103TS)
- 3x 2.5G Ethernet ports
- 2x full-size Mini PCI-E
- 4x COM (RS232/422/485), 2x USB 3.1 & 2x USB 2.0
- Supports DIN-rail mount, wall mount & TPM 2.0

## Specifications

System Mainboard	IB803T
CPU Type	Intel® Atom® x6414RE (1.5GHz, 1.5MB cache, 9W TDP) Intel® Atom® x6212RE (1.2GHz, 1.5MB cache, 6W TDP)
System Speed	Up to 1.5GHz
Memory	1x DDR4 SO-DIMM, Max. 16GB
Rear Panel External I/O	1x DVI-I + 1x HDMI 2x USB 3.1 ports, 2x USB 2.0 port 3x RJ45 2.5G Ethernet port 4x LED indicators (GPIO, WLAN, WWAN) 1x Power button with Green LED 1x 3-pin DC-in terminal block for 9V-36V 2x Antenna hole for WLAN module 2x RS232/422/485 ports for COM#3/COM#4 1x 4-in & 4-out GPIO
Left Panel External I/O	2x RS232/422/485 ports for COM#1/COM#2 1x Antenna hole for WLAN module 1x Line-out/ Mic-in
Right Panel External I/O	2x SIM card slot 1x Antenna hole for WLAN module
Expansion Slots	1x Full-size Mini PCI-E socket (USB 2.0) 1x Full-size Mini PCI-E socket (USB 2.0 + SATA) 1x M.2 B-Key socket (USB 3.0 + PCI-E)
Storage	1x Mini PCI-E slot (mSATA SSD), 1x 2.5" SSD (AGS103TS)
Construction	Aluminum & steel
Chassis Color	Silver & Gray
Mounting	DIN-rail mounting (DIN-rail mount kit included) Desktop or wall mounting (wall mount kit included)
Dimensions	AGS103T : 190mm(W) x 110mm(D) x 52mm (H) 7.48"(W) x 4.33"(D) x 2.05"(H) AGS103TS : 190mm(W) x 110mm(D) x 73mm (H) 7.48"(W) x 4.33"(D) x 2.87"(H)
Weight	1.2kg
Operating Temperature	-20°C~70°C (-4°F~158°F)
Storage Temperature	-40°C ~ 85°C (-40°F~185°F)
Relative Humidity	5~90% @ 60°C, (non-condensing)
Vibration	Operating: 2.0 Grms / 5~500Hz / random operation (with IEC 60068-2-64)
Shock	Operating: 30G/11 ms Duration Non-operating: 40G/11 ms Duration
Certification	CE/ FCC/ LVD
Operating Systems	Win10 and Linux Ubuntu

## Ordering Information

AGS103T-6414RM	Fanless DIN-rail System supports TPM2.0 w/ Intel® Atom® Processor x6414RE, 3x 2.5G Ethernet port, 4x COM, w/o memory, storage, power adaptor
AGS103TS-6414RM	Fanless DIN-rail System supports TPM2.0 w/ Intel® Atom® Processor x6414RE, 3x 2.5G Ethernet port, 4x COM, w/o memory, storage, power adaptor, w/ 2.5" storage slot
AGS103T-6212RM	Fanless DIN-rail System supports TPM2.0 w/ Intel® Atom® Processor x6212RE, 3x 2.5G Ethernet port, 4x COM, w/o memory, storage, power adaptor
AGS103TS-6212RM	Fanless DIN-rail System supports TPM2.0 w/ Intel® Atom® Processor x6212RE, 3x 2.5G Ethernet port, 4x COM, w/o memory, storage, power adaptor, w/ 2.5" storage slot

# AGS103T

## Product View

AGS103T

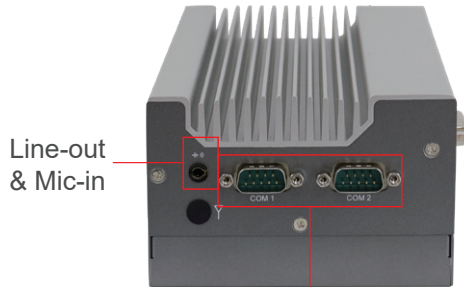


SIM card Slot

AGS103TS

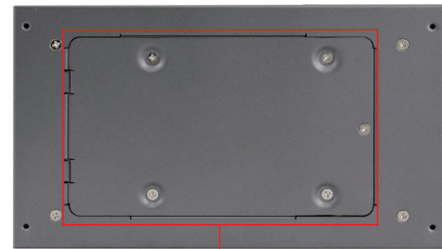


2.5" Storage Slot



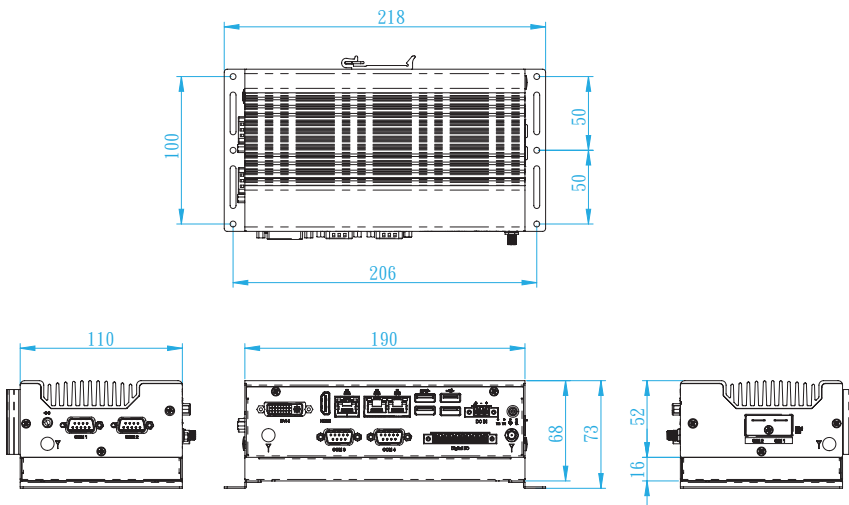
Line-out & Mic-in

COM1 & COM2



Easily Accessible Storage Device

## Dimensions and Drawing



## DIN-rail Mounting

